TE Internal #: 440052-4

PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 2.5 mm [.

098 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder,

Signal, Natural

View on TE.com >

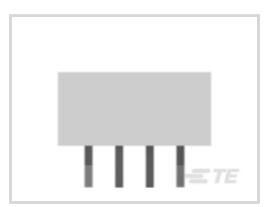


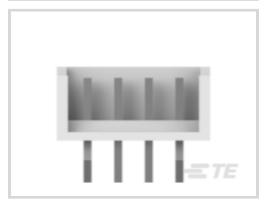
Connectors > PCB Connectors > PCB Headers & Receptacles > AMP HPI 2.5 mm Headers











Connector System: Wire-to-Board

Number of Positions: 4
Number of Rows: 1

Centerline (Pitch): 2.5 mm [ .098 in ]
PCB Mount Orientation: Vertical

All AMP HPI 2.5 mm Headers (78)

# Features

## **Product Type Features**

Number of Positions4Number of Rows1PCB Mount OrientationVertical		
Sealable  Connector & Contact Terminates To  PCB Connector Assembly Type  PCB Mount Header  Number of Positions  Number of Rows  1  PCB Mount Orientation  No  PCB Mount Wertical	Connector System	Wire-to-Board
Connector & Contact Terminates To Printed Circuit Board  PCB Connector Assembly Type PCB Mount Header  Configuration Features  Number of Positions 4  Number of Rows 1  PCB Mount Orientation Vertical	Header Type	Partially Shrouded
PCB Connector Assembly Type  Configuration Features  Number of Positions  Aumber of Rows  PCB Mount Header  4  Number of Positions  Vertical	Sealable	No
Configuration Features  Number of Positions 4  Number of Rows 1  PCB Mount Orientation Vertical	Connector & Contact Terminates To	Printed Circuit Board
Number of Positions4Number of Rows1PCB Mount OrientationVertical	PCB Connector Assembly Type	PCB Mount Header
Number of Rows 1  PCB Mount Orientation Vertical	Configuration Features	
PCB Mount Orientation Vertical	Number of Positions	4
	Number of Rows	1
Electrical Characteristics	PCB Mount Orientation	Vertical
	Electrical Characteristics	
Operating Voltage 250 VAC	Operating Voltage	250 VAC

Natural

**Body Features** 

Primary Product Color



### **Contact Features**

Contact Mating Area Length	3.45 mm[.136 in]
Mating Square Post Dimension	.64 mm[.025 in]
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Bright
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A

### **Termination Features**

Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.4 mm[.134 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

## Mechanical Attachment

Mating Alignment Type	Polarization
Mating Retention	Without
PCB Mount Retention Type	Kinked Tines
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	With

## **Housing Features**

Housing Material	Nylon 66 GF
Centerline (Pitch)	2.5 mm[.098 in]

### **Dimensions**

Connector Length	12.5 mm[.492 in]
Connector Height	6 mm[.236 in]
Connector Width	3.8 mm[.15 in]
PCB Thickness (Recommended)	1 – 1.6 mm[.039 – .063 in]

## **Usage Conditions**

Operating Temperature Range	-25 - 85 °C[-13 - 185 °F]



### Operation/Application

Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	250
Packaging Type	Bag

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 240°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**







# Customers Also Bought



TE Part #DTF13-12PB HDR, 12P, BLK, RA, SN/NI/CU, B

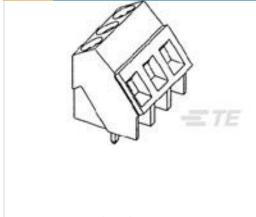


TE Part #440052-6 AMP HPI 2.5 mm Headers



TE Part #1546074-4 4 POS 5.08MM TERMI-BLOK TOP WI





TE Part #1546074-8



TE Part #6-534237-4



TE Part #7-1879352-5



## **Documents**

## **Product Drawings**

2.5MM,HDR,4POS,VERTICAL, CONNECTOR

English

### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_440052-4\_A8.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_440052-4\_A8.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_440052-4\_A8.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 2.5 mm [.098 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, Natural



## Datasheets & Catalog Pages

HPI Connectors QRG

English

**Product Specifications** 

AMP 2.5MM PITCH HPI WIRE TO BOARD SYSTEM.

English

**Application Specification** 

English

Agency Approvals

**UL Report** 

English